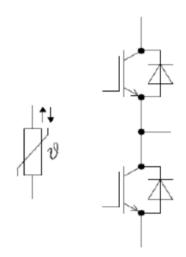


C5 series package: 1200V 600A IGBT module

Datasheet



Equivalent Circuit Schematic

Features:

- Trenchgate Gen.7 IGBT technology
- VCE(sat) with positive temperature coefficient
- High RBSOA capability
- Low static losses: VcE(sat) = 1,5V@25°C
- Low dynamic losses

Options:

- Pre-applied TIM (option +M01)
- Adoption for parallel connection (Vf selection)

Typical Applications:

- Motor Drives
- Solar Applications
- UPS Systems
- Energy Storage



IGBT, Inverter / IGBT Maximum Rated Values

Collector-emitter Voltage	Tvj = 25°C	VCES	1200	V
Continuous DC Collector Current	Tc = 25°C, T _{vj max} ≤ 175°C	ICnom	600	А
	Tc = 100°C, T _{vj max} ≤ 175°C	Ic	732	А
Repetitive Peak Collector Current	tp = 1ms	ICRM	1200	А
Gate-emitter Peak Voltage		VGES	±20	V

Characteristic Values			min.	typ.	max.	
Collector-emitter Saturation Voltage ¹⁾	T _{vj} = 25 Ic = 600A, VgE = 15V T _{vj} = 150 T _{vj} = 175	°C VCEsat	1.40	1.50 1.80 1.86	1.70	V
Gate Threshold Voltage	VCE = VGE, IC = 24mA, Tvj = 25°C	VGEth	5.0	6.0	7.0	V
Gate Charge	VGE = 15V/-8V, VCE = 600V	QG	-	5.7	-	μC
Internal Gate Resistor	Tvj = 25°C	RGint	-	0.43	-	Ω
Input Capacitance	f = 100kHz, T _{vj} = 25°C, VcE = 25V, VgE = 0	V Cies	-	128	_	nF
Reverse Transfer Capacitance	f = 100kHz, T _{vj} = 25°C, VcE = 25V, VgE = 0	V Cres	-	0.80	-	nF
Collector-emitter Cutoff Current	VCE = 1200V, VGE = 0V, Tvj = 25°C	ICES	-	_	1	mA
Gate-emitter Leakage Current	VCE = 0V, VGE = 20V, T _{Vj} = 25°C	IGES	-	-	500	nA
Turn-on Delay Time, Inductive Load		°C tdon	-	216 222 227 230	-	ns
Rise Time, Inductive Load		°C tr	-	72 85 87 94	-	ns
Turn-off Delay Time, Inductive Load		°C tdoff	-	438 478 491 500	-	ns
Fall Time, Inductive Load		°C t _f	-	116 182 202 230	-	ns
Turn-on Energy Loss per Pulse	$ \begin{array}{ll} Ic = 600A, \ VcE = 600V, \ L\sigma = 35nH & Tvj = 25\\ VGE = 15V/-8V, \ RGON = 1\Omega & Tvj = 125\\ di/dt = 6900 \ (Tvj = 175^{\circ}C) & Tvj = 150\\ Tvj = 175 & Tvj = 175 \end{array} $	°C Eon	-	49.9 75.0 85.0 97.0	-	mJ
Turn-off energy Loss per Pulse	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	°C Eoff	_	49.1 55.0 62.0 72.0	_	mJ
SC Data	$\begin{array}{c} \text{VGE} = 15 \text{V}/-8 \text{V} \\ \text{VCE} = 600 \text{V} \end{array} \qquad \begin{array}{c} t_p = 10 \mu \text{s}, \ T_{vj} = 25 \\ t_p = 10 \mu \text{s}, T_{vj} = 150 \\ t_p = 10 \mu \text{s}, T_{vj} = 175 \end{array}$	°C I _{sc}	-	3400 2700 2200	-	А



Thermal Resistance, Junction to Case	Per IGBT	RthJC	-	0.051	-	K/W
Temperature under Switching Conditions		Tvj op	-40		150	°C

Diode, Inverter Maximum Rated Values

Repetitive Peak Reverse Voltage	T _{vj} = 25°C	VRRM	1200	V
Continuous DC Forward Current		lFnom	600	Α
Repetitive Peak Forward Current	tp = 1ms	IFRM	1200	А

Characteristic Values min. typ. max. $T_{Vi} = 25^{\circ}C$ 1.50 2.10 2.40 Forward Voltage¹⁾ IF = 600A, VGE = 0V T_{vj} = 150°C 2.17 T_{vj} = 175°C 2.05 Tvj = 25°C 264 IF = 600A, VR = 600V T_{vj} = 125°C 296 Peak Reverse Recovery Current $-di_F/dt = 6900A/us (T_{vj} = 175^{\circ}C)$ **I**RM Α T_{vj} = 150°C 304 VGE = -8VT_{vj} = 175°C 416 191 Tvj = 25°C IF = 600A, VR = 600V T_{vj} = 125°C 35.8 Recovery Charge QR μC $-di_F/dt = 6900A/us (T_{Vj} = 175^{\circ}C)$ 64.0 $T_{Vj} = 150^{\circ}C$ VGE = -8VTvj = 175°C 87.5 $T_{vj} = 25^{\circ}C$ 11.7 IF = 600A, VR = 600V T_{vj} = 125°C 20.7 Reverse Recovery Energy $-di_F/dt = 6900A/us (T_{vj} = 175^{\circ}C)$ mJ Erec T_{vj} = 150°C 25.4 VGE = −8V T_{vj} = 175℃ 41.8 Thermal Resistance, Junction to Case Per FRD K/W 0.065 RthJC Temperature under Switching °C Tvj op -40 150 Conditions²⁾

NTC-Thermistor / NTC Maximum Rated Values

				٠٦ ٢٠		
Rated Resistance	TNTC = 25°C	R25	_	5	-	ΚΩ
Deviation of R100 R100	TNTC = 100°C, R100 = 465Ω	ΔR/R	-7.3	ı	7.3	%
Power Dissipation	TNTC = 25°C	P25	_	ı	10	mW
B-Value B	R2 = R25 exp[B25/50(1/T2-1/(298.15K))]	B25/50	_	3380	-	K
	R2 = R25 exp[B25/80(1/T2-1/(298.15K))]	B25/80	_	3470	-	К
	R2 = R25 exp[B25/100(1/T2-1/(298.15K))]	B25/100	_	3520	-	К

min. tvp. max.





Module

Isolation Test Voltage	RMS, f=50Hz, t=1min	VisoL	3.0	kV
Material of Module Baseplate			Cu	
Internal Isolation			ZTA	
Creepage Distance	Terminal to heatsink, min Terminal to terminal, min		14.5 13	mm
Clearance	Terminal to heatsink, min Terminal to terminal, min		12.5 10	mm
Comparative Tracking Index		СТІ	200 ²⁾	

min. typ. max.

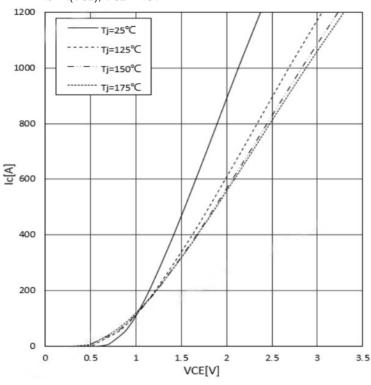
Stray Inductance Module		LsCE	_	20	_	nΗ
Module Lead Resistance, Terminals-Chip	Tc = 25°C, Per Switch	Rcc'+ee'	-	0.83	-	mΩ
Storage Temperature		Tstg	-40	_	125	°C
Mounting Torque for Module Mounting	Screw M5 / M5	М	3.0	_	6.0	Nm
Power terminal installation torque	Screw M6 / M6	М	3.0	_	6.0	Nm
Weight		G	-	345	_	g

¹⁾ Terminal impedance is not included. 2) CTI is about 200.

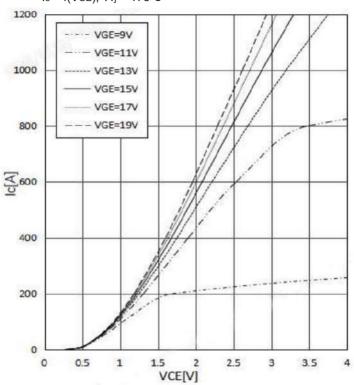


Circuit Diagram

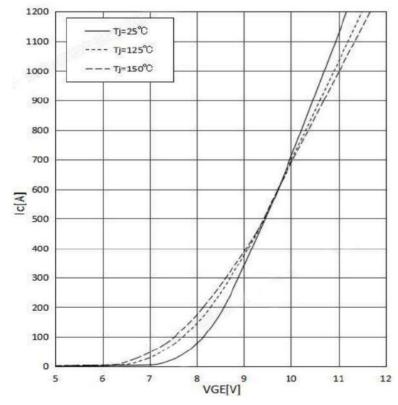
Output characteristic IGBT, Inverter (typical), IGBT Ic = f(VCE), VGE = 15V



Output characteristic IGBT, Inverter (typical), IGBT $I_c = f(VcE)$, $T_{vj} = 175$ °C

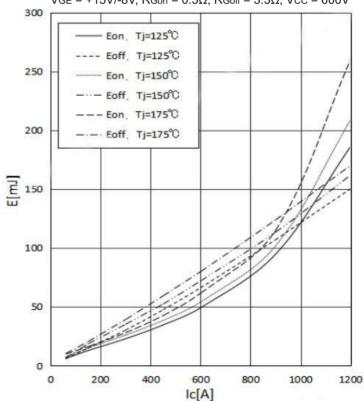


Transfer characteristic IGBT,Inverter(typical), IGBT $I_c = f(V_{GE})$, $V_{CE} = 20V$

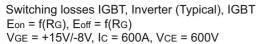


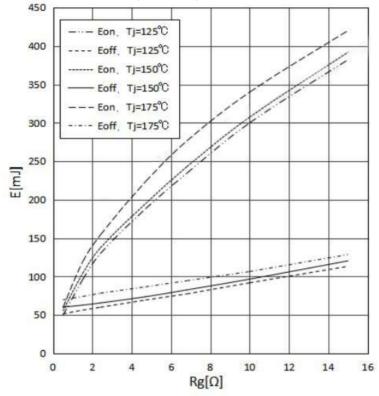
Switching losses IGBT, Inverter (Typical), IGBT Eon = f(Ic), Eoff = f(Ic)



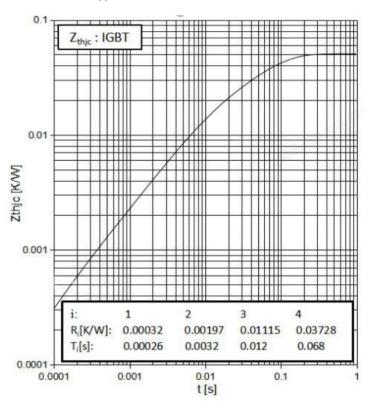




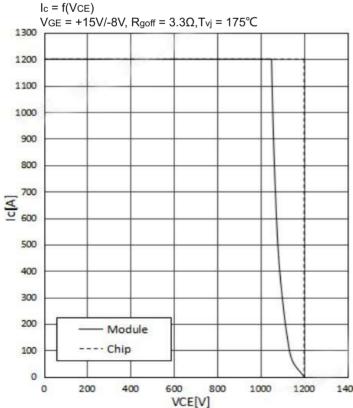




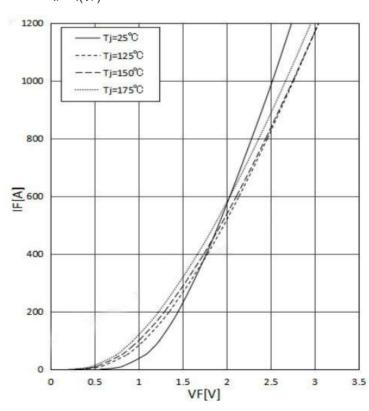
Transient thermal impedance IGBT,Inerter $Z_{thJC} = f(t)$



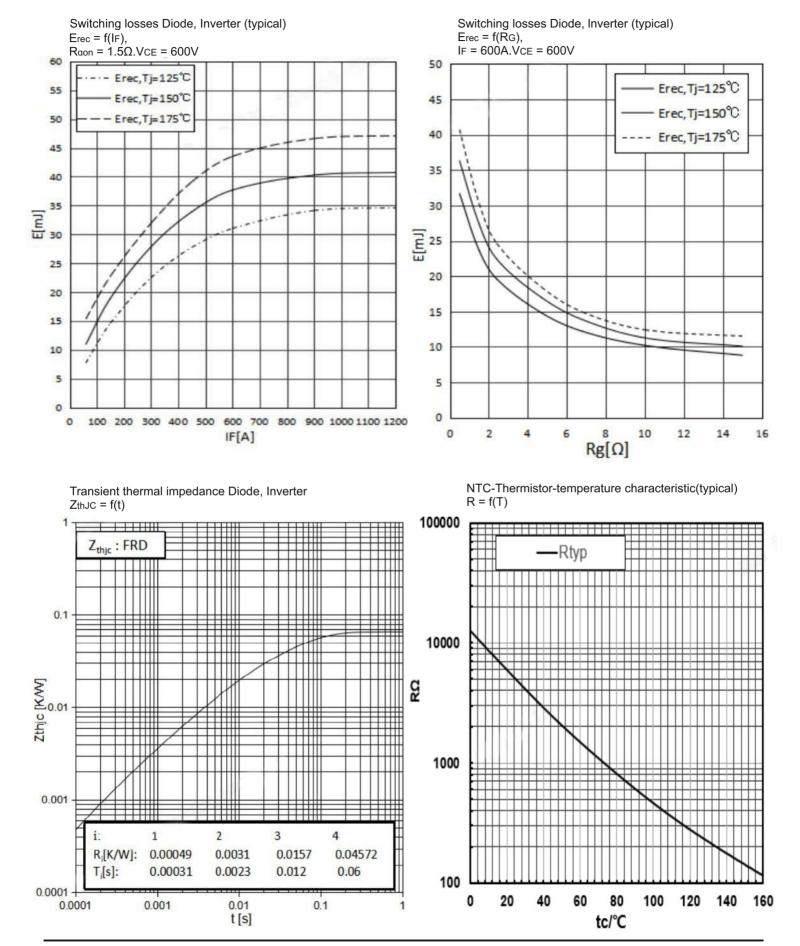
Reverse bias safe operating area IGBT,Inverter(RBSOA)



Forward characteristic of Diode, Inverter (typical) IF = f(VF)

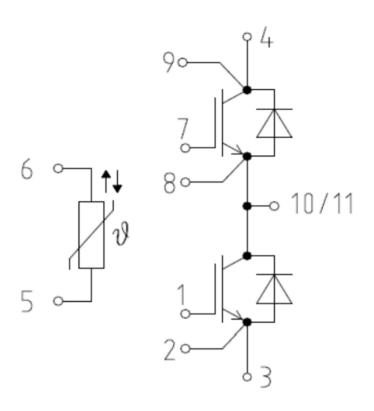




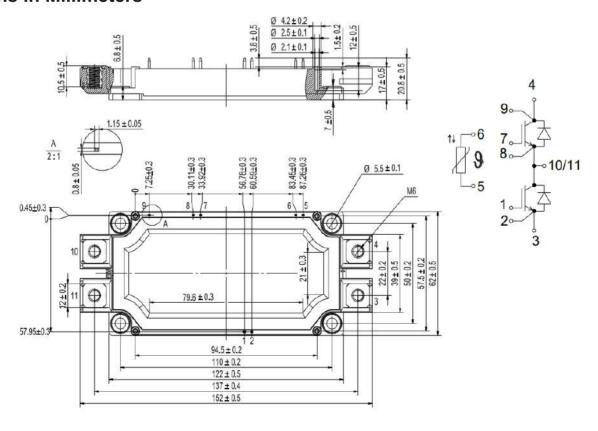




Circuit diagram



Package outlines Dimensions in Millimeters





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-9- Rev.1 2024-12-***